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**Assembly Notes:**

- **ZZ2**
  - These assemblies are ESD sensitive. ESD precautions shall be observed.

- **ZZ3**
  - These assemblies must be clean and free from flux and all contaminants. Use of no-clean flux is not acceptable.

- **ZZ4**
  - These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

**Label Table**

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<th>Variant</th>
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